

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

49016

In the Application of:)
JAKOB et al.)
)
Filing Date: November 18, 2005) Art Unit: 2813
)
Serial No. 10/536,725) Examiner: L.M. Menz

For: **METHOD AND DEVICE FOR MACHINING A WAFER,
IN ADDITION TO A WAFER COMPRISING A
SEPARATION LAYER AND A SUPPORT LAYER**

Response

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

June 30, 2008

Dear Sir:

In response to the June 2, 2008 Office Action, Applicants respond as follows.